



Appl. No. 10/685,824
Declaration under 37 C.F.R. §1.131

Patent/Docket No. 24061.24
Customer No. 000042717

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:
Lin, et al.

Serial No.: 10/685,824

Filed: October 13, 2003

For: Multi-Sensing Level MRAM Structure

Group Art Unit: 2818

Examiner: Huynh, Andy

Confirmation No.: 5264

Mail Stop AF

Commissioner of Patents:
P. O. Box 1450
Alexandria, VA 22313-1450

DECLARATION UNDER 37 C.F.R. § 1.131

I, Denny D. Tang, declare and say that:

1. I am one of the three sole inventors of the subject matter disclosed and claimed in the above-identified application.
2. At all times set forth herein, I was an employee of Taiwan Semiconductor Manufacturing Co., Ltd., the assignee of the above identified application (hereinafter referred to as "TSMC"), in Taiwan.
3. The invention claimed in the above-identified application was reduced to practice prior to October 3, 2003, the filing date of U.S. Patent App. Pub. No. 2005/0073878, as evidenced by the TSMC Invention Disclosure form that I approved before October 3, 2003. A redacted copy of the TSMC Invention Disclosure form is attached.
4. All of the activities described above occurred in Taiwan.

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I declare that all statements made herein of my knowledge are true and that all statements made on information and belief are believed to be true and that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code.

✓ Denny D. Tang
Denny D. Tang
Date: ✓ 2006.02.20